

## Special Issue

# Advances of Semiconductor Nanostructures

### Message from the Guest Editor

Since gate-all-around nanowire devices were combined with 3D integration, semiconductor nanostructures have promise to scale up the overall performance of electronics technology. Traditional scaling-down has allowed the construction of components and final chips with higher speed and density, lower power, increased functionality, etc. However, a change paradigm suggests that “More Moore” and “More Than Moore” will evolve towards novel strategies involving new materials, advanced devices, or higher-value nanosystems. This Special Issue of *Materials* attempts to cover the recent advances in semiconductor nanostructures for logic and memory, sensors and actuators, biological and mechanical nanosystems, etc.

### Guest Editor

Prof. Dr. Anna Vilà

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### Deadline for manuscript submissions

closed (30 June 2020)



## Materials

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## About the Journal

### Message from the Editor-in-Chief

*Materials* (ISSN 1996-1944) was launched in 2008. The journal covers twenty-five comprehensive topics: biomaterials, energy materials, advanced composites, advanced materials characterization, porous materials, manufacturing processes and systems, advanced nanomaterials and nanotechnology, smart materials, thin films and interfaces, catalytic materials, carbon materials, materials chemistry, materials physics, optics and photonics, corrosion, construction and building materials, materials simulation and design, electronic materials, advanced and functional ceramics and glasses, metals and alloys, soft matter, polymeric materials, quantum materials, mechanics of materials, green materials, general. *Materials* provides a unique opportunity to contribute high quality articles and to take advantage of its large readership.

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### Editor-in-Chief

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